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Product Termination Notification



Product Group: SIL/Wed Jun 14, 2023/PTN-SIL-030-2023-REV-0

Conversion to Copper (Cu) Wire – SQ2348ES

For further information, please contact your regional Vishay office.

CONTACT INFORMATION

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Description of Change: The affected part number listed in this notification will be converted to a Copper wire material set. The new ordering code is SQ2348CES-T1_GE3, which has the exact same product performance and fit as SQ2348ES. There will be no change to the wafer fab or assembly location (Note: parts with _BE3 suffix will be consolidated to single assembly location in China). There will be no changes to the parameters on the datasheet (reference: SQ2348CES Doc # 62082 Rev.A).

Classification of Change: Standardization of materials

Expected Influence on Quality/Reliability/Performance: None

Part Numbers/Series/Families Affected: SQ2348ES-T1_GE3, SQ2348ES-T1_BE3,

Vishay Brand(S): Vishay Siliconix

Time Schedule:

Last Time Buy Date: Sun Dec 17, 2023

Last Time Ship Date: Sun Jun 16, 2024

Sample Availability: Qualified samples of replacement product are available on request.

Product Identification: SQ2348CES-T1_GE3

Qualification Data: AEC Q101 qualification data of replacement product is available. Qualification PPAP is available now.

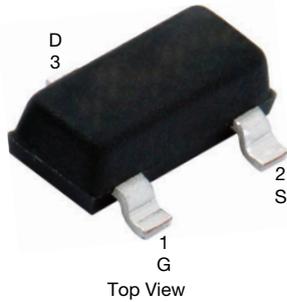
This PTN is considered approved, without further notification, unless we receive specific customer concerns before Sun Dec 17, 2023 or as specified by contract.

Issued By: Vishay Siliconix, business-americas@vishay.com



Automotive N-Channel 30 V (D-S) 175 °C MOSFET

SOT-23 (TO-236)



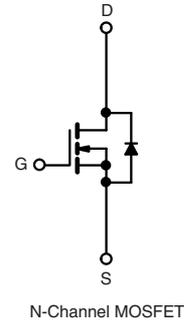
Marking Code: 90YXX

FEATURES

- TrenchFET® power MOSFET
- AEC-Q101 qualified
- 100 % R_g and UIS tested
- Material categorization:
for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE



PRODUCT SUMMARY	
V _{DS} (V)	30
R _{DS(on)} (Ω) at V _{GS} = 10 V	0.024
R _{DS(on)} (Ω) at V _{GS} = 4.5 V	0.032
I _D (A)	8
Configuration	Single

ORDERING INFORMATION	
Package	SOT-23
Lead (Pb)-free and halogen-free	SQ2348CES (for detailed order number please see www.vishay.com/doc?79771)

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V _{DS}	30	V
Gate-source voltage		V _{GS}	± 20	
Continuous drain current	T _C = 25 °C ^a	I _D	8	A
	T _C = 125 °C		5.3	
Continuous source current (diode conduction)		I _S	3.8	
Pulsed drain current ^b		I _{DM}	32	
Single pulse avalanche current	L = 0.1 mH	I _{AS}	15.5	
Single pulse avalanche energy		E _{AS}	12	mJ
Maximum power dissipation	T _C = 25 °C	P _D	3	W
	T _C = 125 °C		1	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-ambient	PCB Mount ^c	R _{thJA}	166	°C/W
Junction-to-foot (drain)		R _{thJF}	50	

Notes

- Package limited
- Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2 %
- When mounted on 1" square PCB (FR4 material)



SPECIFICATIONS ($T_C = 25\text{ }^\circ\text{C}$, unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$		30	-	-	V
Gate-source threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$		1.5	2.0	2.5	
Gate-source leakage	I_{GSS}	$V_{DS} = 0\text{ V}, V_{GS} = \pm 20\text{ V}$		-	-	± 100	nA
Zero gate voltage drain current	I_{DSS}	$V_{GS} = 0\text{ V}$	$V_{DS} = 30\text{ V}$	-	-	1	μA
		$V_{GS} = 0\text{ V}$	$V_{DS} = 30\text{ V}, T_J = 125\text{ }^\circ\text{C}$	-	-	50	
		$V_{GS} = 0\text{ V}$	$V_{DS} = 30\text{ V}, T_J = 175\text{ }^\circ\text{C}$	-	-	150	
On-state drain current ^a	$I_{D(on)}$	$V_{GS} = 10\text{ V}$	$V_{DS} \geq 5\text{ V}$	10	-	-	A
Drain-source on-state resistance ^a	$R_{DS(on)}$	$V_{GS} = 10\text{ V}$	$I_D = 12\text{ A}$	-	0.020	0.024	Ω
		$V_{GS} = 10\text{ V}$	$I_D = 12\text{ A}, T_J = 125\text{ }^\circ\text{C}$	-	-	0.036	
		$V_{GS} = 10\text{ V}$	$I_D = 12\text{ A}, T_J = 175\text{ }^\circ\text{C}$	-	-	0.042	
		$V_{GS} = 4.5\text{ V}$	$I_D = 8\text{ A}$	-	0.026	0.032	
Forward transconductance ^b	g_{fs}	$V_{DS} = 15\text{ V}, I_D = 3\text{ A}$		-	12	-	S
Dynamic ^b							
Input capacitance	C_{iss}	$V_{GS} = 0\text{ V}$	$V_{DS} = 15\text{ V}, f = 1\text{ MHz}$	-	450	540	pF
Output capacitance	C_{oss}			-	95	125	
Reverse transfer capacitance	C_{rss}			-	39	50	
Total gate charge ^c	Q_g	$V_{GS} = 10\text{ V}$	$V_{DS} = 15\text{ V}, I_D = 5.5\text{ A}$	-	8.15	14.5	nC
Gate-source charge ^c	Q_{gs}			-	1.65	-	
Gate-drain charge ^c	Q_{gd}			-	1.25	-	
Gate resistance	R_g	f = 1 MHz		8.65	13	27	Ω
Turn-on delay time ^c	$t_{d(on)}$	$V_{DD} = 15\text{ V}, R_L = 3.4\text{ }\Omega$ $I_D \cong 4.4\text{ A}, V_{GEN} = 10\text{ V}, R_g = 1\text{ }\Omega$		-	6	7	ns
Rise time ^c	t_r			-	4	12	
Turn-off delay time ^c	$t_{d(off)}$			-	18	32	
Fall time ^c	t_f			-	4	9	
Source-Drain Diode Ratings and Characteristics ^b							
Pulsed current ^a	I_{SM}			-	-	32	A
Forward voltage	V_{SD}	$I_F = 3.5\text{ A}, V_{GS} = 0\text{ V}$		-	0.81	1.2	V
Body diode reverse recovery time	t_{rr}	$I_F = 4\text{ A}, di/dt = 100\text{ A/us}$		-	10	20	ns
Body diode reverse recovery charge	Q_{rr}			-	5	10	nC
Reverse recovery fall time	t_a			-	7	-	ns
Reverse recovery rise time	t_b			-	3	-	
Body diode peak reverse recovery current	$I_{RM(REC)}$					-	-0.98

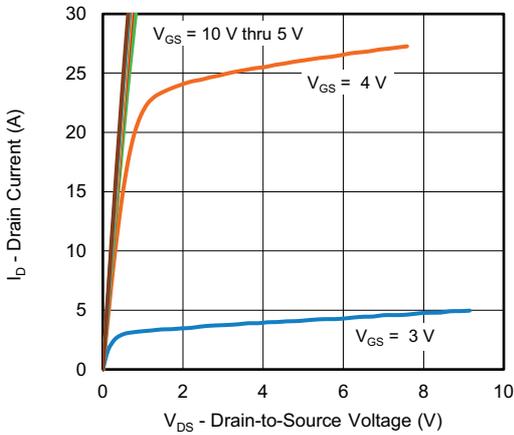
Notes

- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\text{ }\%$
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

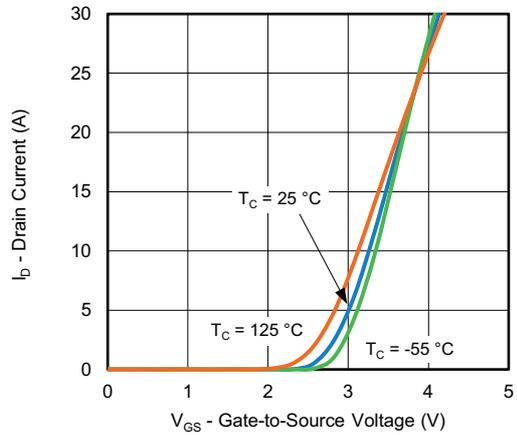
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



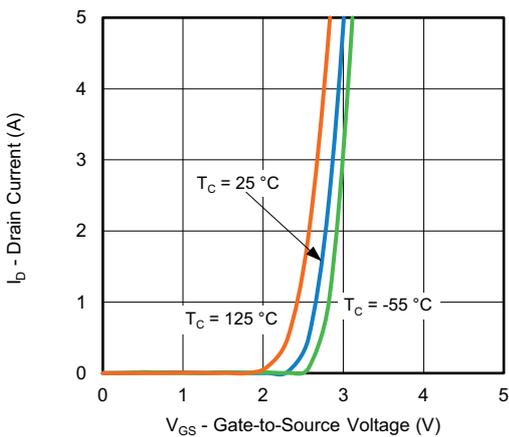
TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$, unless otherwise noted)



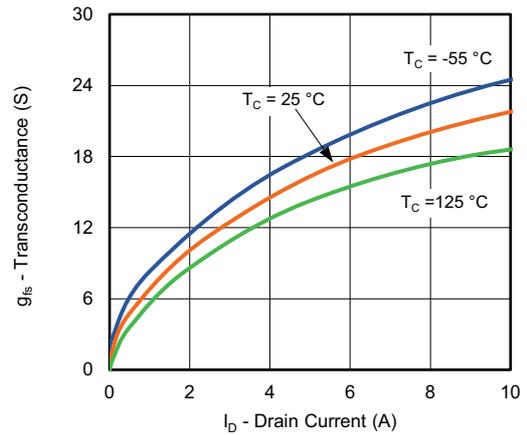
Output Characteristics



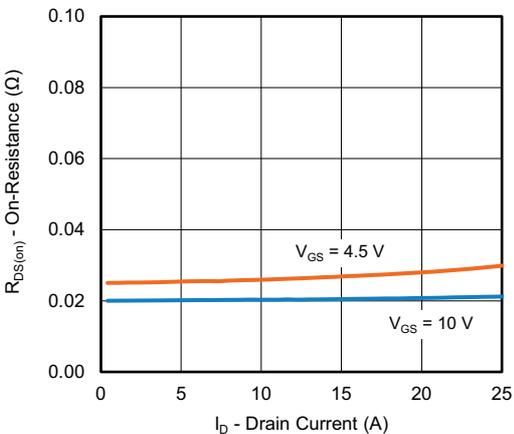
Transfer Characteristics



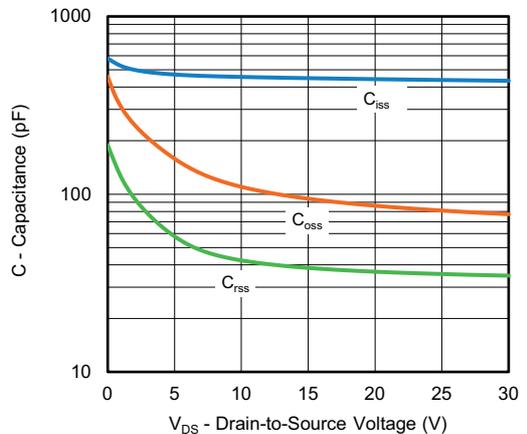
Transfer Characteristics



Transconductance



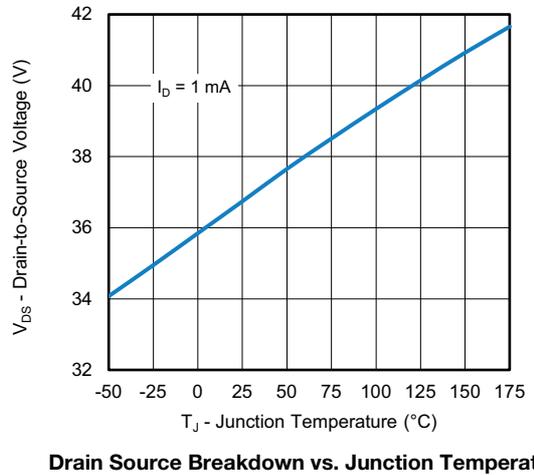
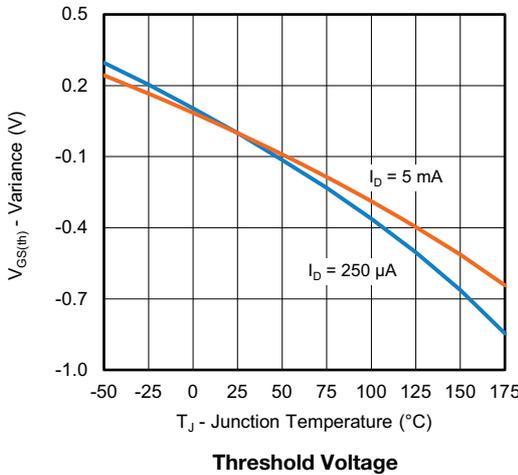
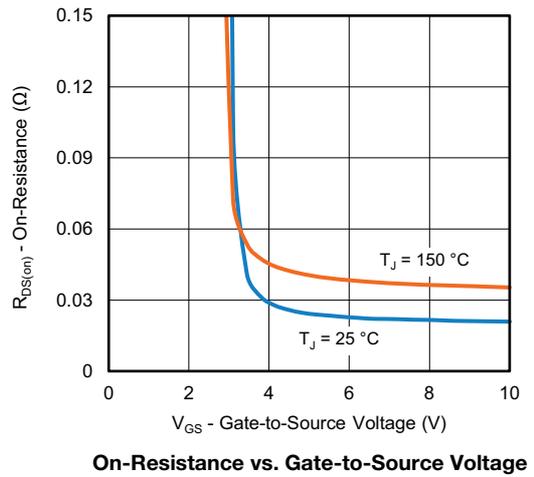
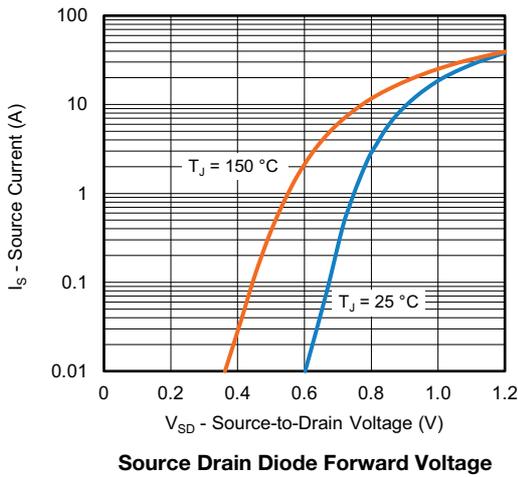
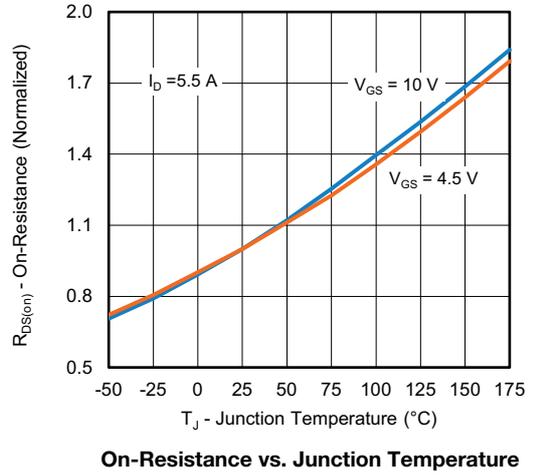
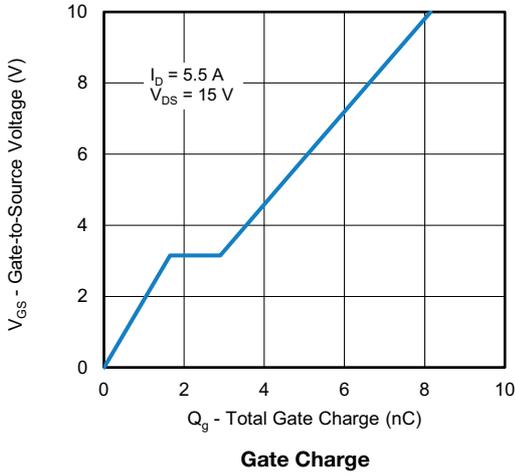
On-Resistance vs. Drain Current



Capacitance

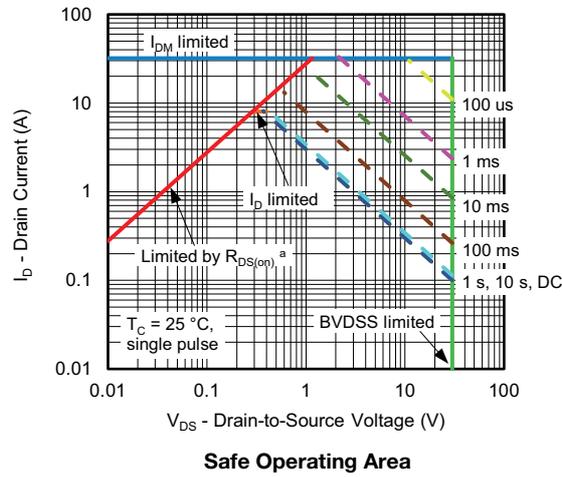


TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$, unless otherwise noted)





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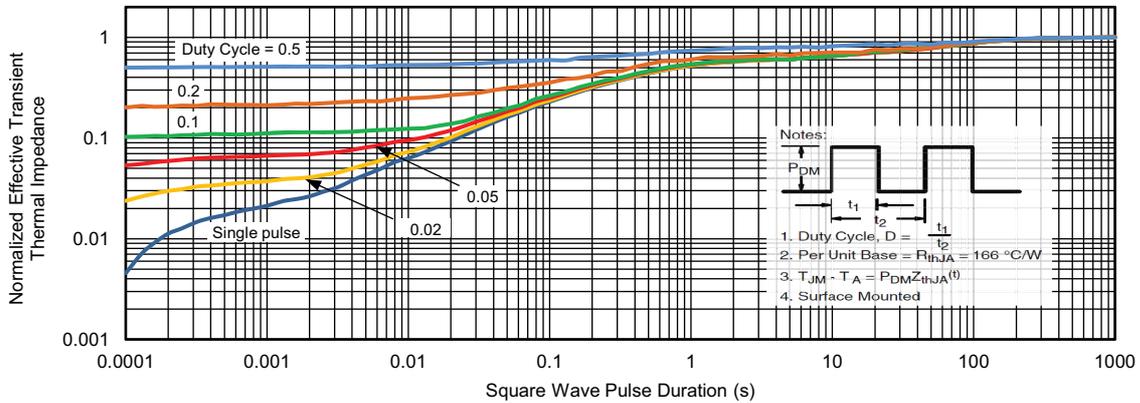


Note

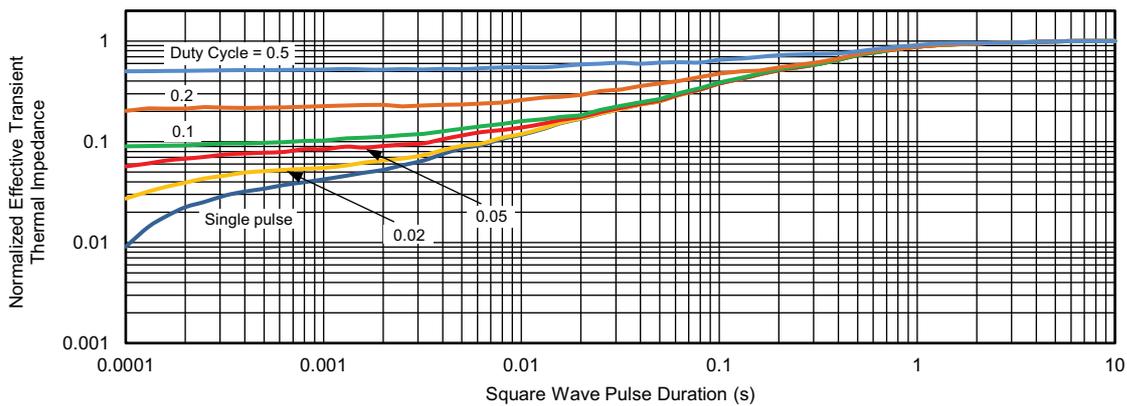
a. $V_{GS} >$ minimum V_{GS} at which $R_{DS(on)}$ is specified



THERMAL RATINGS ($T_A = 25\text{ }^\circ\text{C}$, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient ($25\text{ }^\circ\text{C}$)
 - Normalized Transient Thermal Impedance Junction-to-Foot ($25\text{ }^\circ\text{C}$)
 are given for general guidelines only to enable the user to get a “ball park” indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?62082.



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